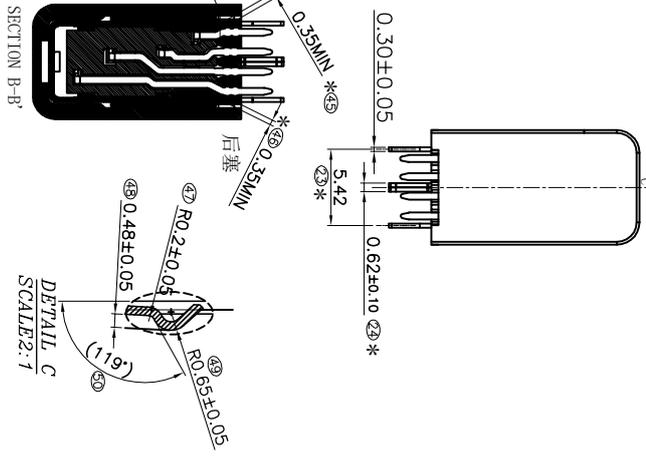
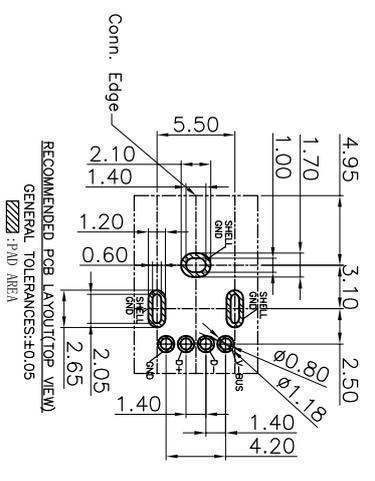
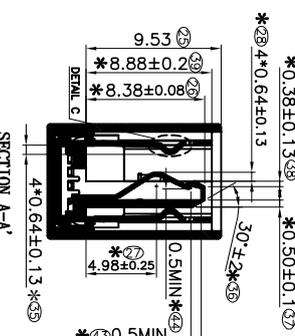
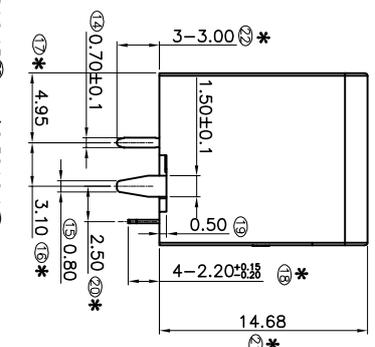
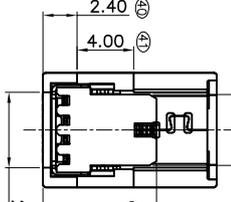
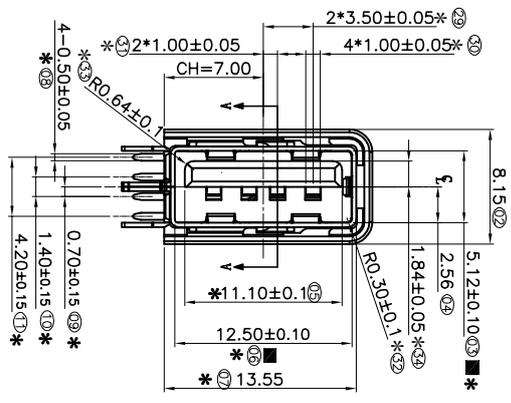
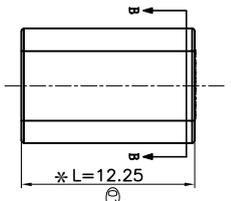


# RoHS 客户图

目錄 MAPX	变更内容 MODIFICATION	日期 DATE
A0	NEW	09-10-20

NOTE:  
1. Material:  
Housing: Thermoplastics,UL94V-0;(Halogen free), LCP,EI130i,Black/BLACK  
Cap:Thermoplastics,UL94V-0;(Halogen free), LCP,EI130i,Black/BLACK  
Contact: Copper Alloy T=0.25mm(C7025)  
Inner Shell: Copper Alloy T=0.30mm(C5191)  
Outer Shell: Thermoplastics,UL94V-0;(Halogen free),LCP,EI130i,Black

2. FINISH:  
Contact: Au 30u" Plated on Contact Area,  
150u" Min,Bright Tin Plated on Solder Tails Area,  
50u" Min,Nickel Underplating Over All.
3. Specification:  
3.1: Rated current: 3.2 A  
Insulation Resistance:  
1000MΩ Min. at 500V/DC for 1Minute.  
Withstanding voltage: 500 VAC/minute  
Contact Resistance: 30 m ohms Max.
- 3.2: MECHANICAL  
Mating force: 20N(2.04kgf) Max.  
Unmating force(Without lock):10N(1.02kgf) Min.  
Durability: 5000 cycles Min.
4. OUTER SHELL MINIMUM THICKNESS: 0.5mm Min.
5. 带"⊗" 尺寸为A;带"⊙" 尺寸为重点尺寸,带"■" 尺寸为CP尺寸;  
Ordering information



5	后塞	HUB139L-1B1-BX00-H	LCP, BK (无卤)	
4	护套	HUB89L-1B1-BX00-H	LCP, BK (无卤)	
3	铜壳	GUB154P-1A3-SN12	镀镍盐雾(无卷边)	
2	胶芯	HUB26L-1D1-BX00-H	LCP, BK (无卤)	
1	端子	GUB44F-1D1-VP30	镀半金亮锡30u"	
项次 NO.	品名 NAME	料号 P/N	表面处理 PLATING	备注 REMARK

## 产品图

深圳市鑫风雷电子有限公司  
Shenzhen xinfenglei Electronics Co., Ltd

公差一览表 TOLERANCE UNLESS OTHERWISE SPECIFIED		单位 UNITS		MM	
X	±0.30	X'	±5'		
X	±0.25	X'	±2'		
XX	±0.20	XX'	±1'		
XXX	±0.15	XXX'	±0.5'		

制图 DRAWING	王冠 Wangguan	产品料号 PRODUCT PART NO.	00603-U2AF004-X
审核 CHECK	雷永健 Leiyongjian	产品名称 PRODUCT NAME	USB AF 侧插加护套
批准 APPRO	雷永健 Leiyongjian	联系方式 CONTACT	mail:box:sale1@xfl.com.com www.xfl.com.com